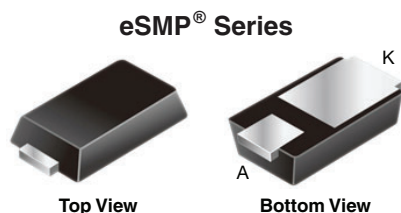


Surface-Mount Schottky Barrier Rectifiers



MicroSMP (DO-219AD)

Anode  Cathode

FEATURES

- Very low profile - typical height of 0.65 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	20 V, 30 V
I_{FSM}	30 A
V_F at $I_F = 2.0$ A	0.47 V
T_J max.	150 °C
Package	MicroSMP (DO-219AD)
Circuit configuration	Single

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)				
PARAMETER	SYMBOL	MSS2P2	MSS2P3	UNIT
Device marking code		22	23	
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	V
Maximum average forward rectified current (fig. 1)	$I_{F(AV)}$	2.0		A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	30		A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150		°C

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.44	-	V
	I _F = 2.0 A			0.52	0.60	
	I _F = 1.0 A	T _A = 125 °C		0.36	-	
	I _F = 2.0 A			0.47	0.55	
Maximum reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	15	250	μA
		T _A = 125 °C		6.0	20	mA
Typical junction capacitance	4.0 V, 1 MHz		C _J	65	-	pF

Notes
⁽¹⁾ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	MSS2P2	MSS2P3	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	105		°C/W
	R _{θJL} ⁽¹⁾	15		
	R _{θJC} ⁽¹⁾	20		

Note
⁽¹⁾ Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas $R_{\theta JL}$ is measured at the terminal of cathode band. $R_{\theta JC}$ is measured at the top center of the body

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
MSS2P3-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel
MSS2P3HM3_A/H ⁽¹⁾	0.006	H	4500	7" diameter plastic tape and reel

Note
⁽¹⁾ AEC-Q101 qualified

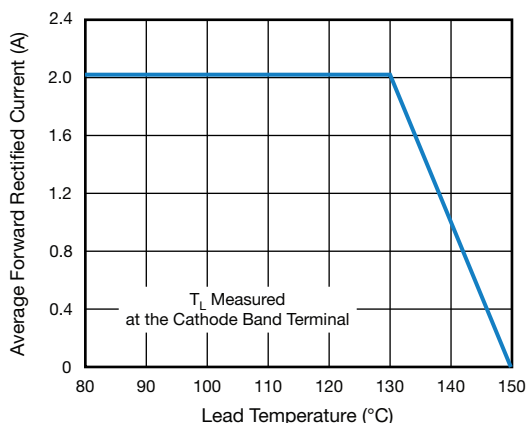
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

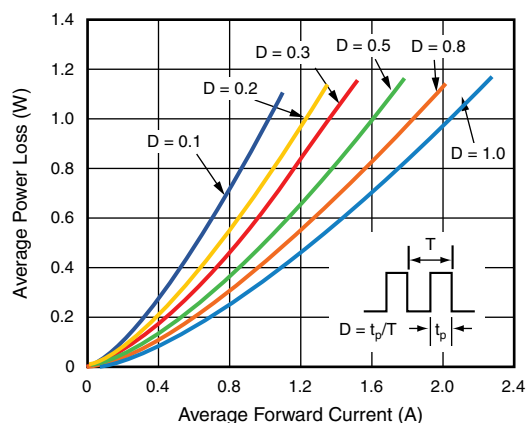


Fig. 2 - Forward Power Loss Characteristics

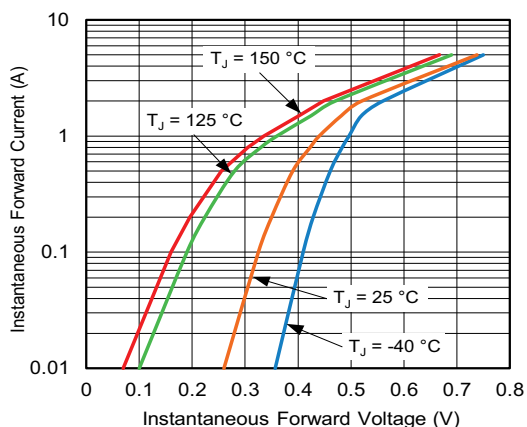


Fig. 3 - Typical Instantaneous Forward Characteristics

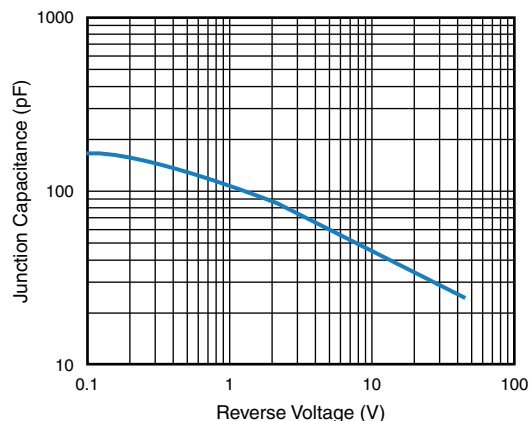


Fig. 5 - Typical Junction Capacitance

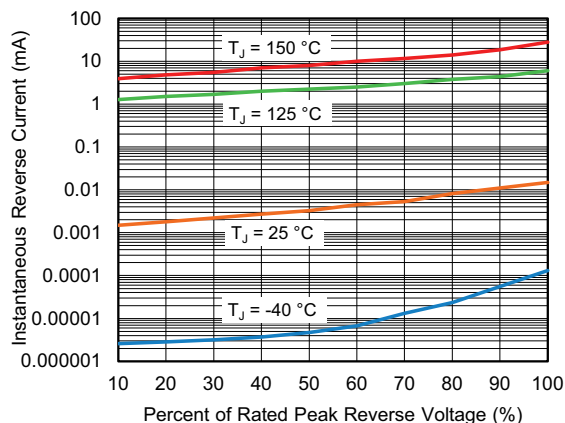


Fig. 4 - Typical Reverse Characteristics

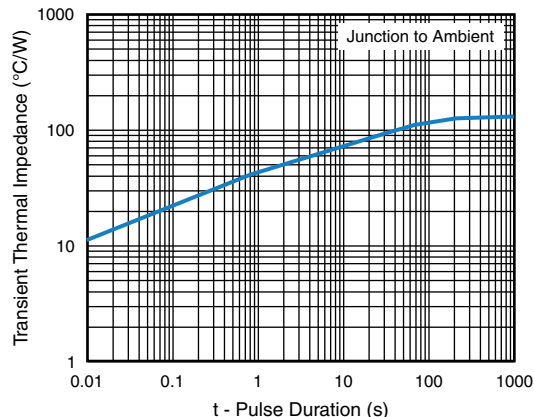
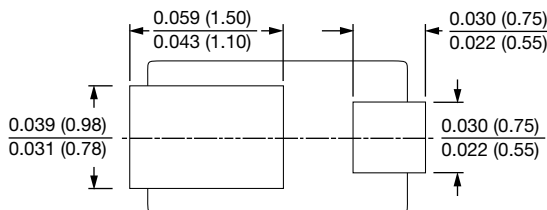
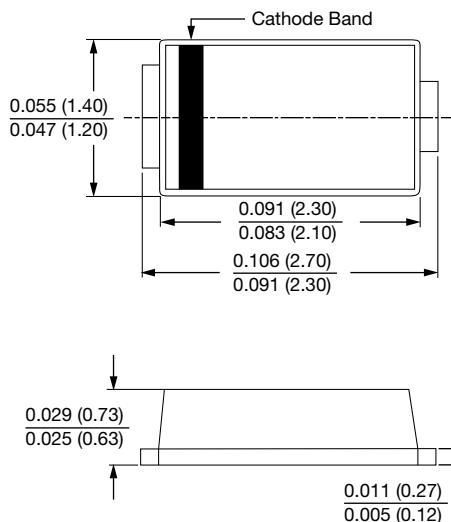


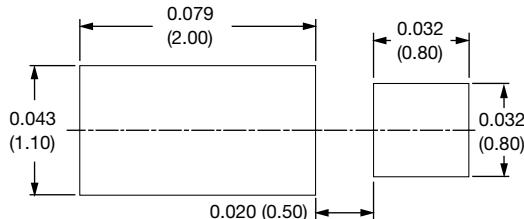
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

MicroSMP (DO-219AD)



Mounting Pad Layout





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